

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**APPLICANT:** Machida, A. et al.

**ATTY DOCKET NO.:** 09792909-5737

**SERIAL NO.:** Not yet assigned

**GROUP ART UNIT:** not yet assigned

**DATE FILED:** September 26, 2003

**EXAMINER:** not yet assigned

**INVENTION:** SEMICONDUCTOR DEVICE AND ITS MANUFACTURING METHOD

which is a Divisional of the following copending U.S. Application:

**APPLICANT:** Machida, A. et al.

**ATTY DOCKET NO.:** 09792909-4676

**SERIAL NO.:** 09/718,269

**GROUP ART UNIT:** 2818

**DATE FILED:** November 22, 2000

**EXAMINER:** Le, Thao, P.

**INVENTION:** SEMICONDUCTOR DEVICE AND ITS MANUFACTURING METHOD

**PRELIMINARY AMENDMENT**

Mail Stop Patent Application  
Commissioner for Patents  
P. O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

Please amend the accompanying application as follows:

**In the Specification**

On page 1, after the title and before the heading, "Field of the Invention," please insert the following:

**--RELATED APPLICATION DATA**

The present application claims priority to Japanese Application No. JP11-334978 filed November 25, 1999, and is a divisional of United States Application Serial No. 09/718,269, filed November 22, 2000, both of which are incorporated herein by reference to the extent permitted by law.--